

Bridge to the Sustainable Growth with Innovative Integrated Electronic Systems

From super low power edge computing and car electronics to AI systems



4th

CIES

Technology

Forum

March 22 - 23, 2018

DAY 1

Registration

www.cies.tohoku.ac.jp/ 4th_forum/entry.html

Registration fee: Free
Banquet fee: 6,000JPY
Pre-registration deadline:
March 15, 2018

Tohoku University Center for Innovative Integrated Electronic Systems

468-1 Aramaki Aza Aoba, Aoba-ku, Sendai, Miyagi, 980-8572, JAPAN TEL +81-22-796-3410 FAX +81-22-796-3432 support-office@cies.tohoku.ac.jp

International Symposium

March 22, 2018

Station Conference Tokyo, Sapia Tower 5F 501ABS 1-7-12 Marunouchi, Chiyoda-ku, Tokyo

Invited Speakers Yong Kyu Lee (Samsung)

David Eggleston (GLOBALFOUNDRIES) Kazuhiro Ohnishi (Renesas Electronics) Hideo Ohno (Tohoku University)

Naoya Eguchi (Fuji Electric)

Yoshikazu Takahashi (Tohoku University)

Chair T. Endoh (Tohoku Univ.)

Committee T. Endoh, T. Hanyu, S. Ikeda,

Y. Mizomoto, T. Shinada (Tohoku Univ.)

Secretariat T. Shinada, M. Maruyama (Tohoku Univ.)

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4th CIES **Technology Forum**

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Sapia Tower 5F 501ABS





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<<< Registration desk open at 9:45am>>>

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10:30-10:45	Opening remarks	Tetsuo Endoh (Tohoku University)
10:45-11:30	Invited talk 1 STT-MRAM Embedded Technology in 28-nm FDSOI Logic Process for Mass-Production	Yong Kyu Lee (Samsung)
11:30-12:15	Invited talk 2 eMRAM: Winning the IoT and AI Applications	David Eggleston (GLOBALFOUNDRIES)
12:15-13:45	Lunch	
13:45-14:30	Invited talk 3 Solution Challenges for IoT Society and Device Technology to Realize It	Kazuhiro Ohnishi (Renesas Electronics)
14:30-15:15	Invited talk 4 Spintronics Nanoelectronics - Faster, Smarter, and Smaller -	Hideo Ohno (Tohoku University)
15:15-15:30	Break	
15:30-16:15	Invited talk 5 Evolution of Power Electronics and Expectations for WBG Power Semiconductor	Naoya Eguchi (Fuji Electric)
16:15-17:00	Invited talk 6 Advanced Power Module Technology - Interface between Power Electronics and Power Devices -	Yoshikazu Takahashi (Tohoku University)
17:00-17:10	Closing remarks	Shoji Ikeda (Tohoku University)
17:30-19:00	Banquet (Station Conference Tokyo, Sapia Tower 5F)	

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